



## **N9000**

### **PTFE Laminates**

Nelco N9000 PTFE laminates are designed for critical RF/Microwave components, antennas, power amplifiers and subassemblies. Superior mechanical and electrical performance make the N9000 PTFE laminate system the material of choice for your lowest electrical loss and high frequency applications.

### **Key Features**

### Complete spectrum of controlled dielectric constants

- Dk of 2.08 through Dk of 4.50
- Reinforced PTFE laminate with a dielectric constant less than 2.17 available for very low loss antenna designs
- PTFE / glass ratio tightly controlled
- Available in sheets up to 80 inches long (2.03 meters) by 48 inches wide (1.22 meters)

### Enhanced N9000 IM materials available

- Superior passive intermodulation in antenna and high power designs
- Offers two-tone passive intermodulation performance of less than -163 dBc (guranteed by measurement and batch to bach with N copper).

### Consistent Quality (ISO 9001)

- Statistic Process Control "SPC" methods provide consistent dielectric values from sheet to sheet and batch to batch
- Meets UL 94V-0 and IPC-4103/A specifications and measured according to IPC-TM-650
- All AGC Nelco materials are RoHS compliant
- Each batch is tested and a test report is provided

### Optimized N9000 PTFE processing

- Superior guaranteed foil adhesion
- Superior solvent absorption resistance

### **Claddings Available**

- RTFoil: 18, 35 and 70 μm (0.5, 1 and 2 oz)
- Shiny Copper: 18, 35 and 70 μm (0.5, 1 and 2 oz)
- N Copper: 18, 35 and 70 μm (0.5, 1 and 2 oz)
- Heavy backed material: Aluminum and brass upon request

## **Applications**

- 5G All Frequencies Band
- Massive MIMO
- Antennas
- Wireless Communications
- Power Amplifiers
- Multi Hi Power Passive Circuits
- Automotive Applications
- Digital/Microwave Hybrid Multilayer PCB Assemblies
- Millimeter Wave Components
- Satellite Communications
- Microwave Links

### **Available Materials**

NY Series: PTFE / woven-glass composite. Low glass to PTFE ratio for lowest loss applications.

NX Series: PTFE / woven-glass composite. Medium glass to PTFE ratio for increased mechanical strength.

NH Series: PTFE / woven-glass / ceramic composite.

Medium glass to PTFE ratio with ceramic added for thermal stability and Dk uniformity at higher Dks.

NL Series: PTFE / woven glass / ceramic composite. Higher Dk, Low glass to PTFE ratio for low loss applications.

UL file number: E36295

# N9000 PTFE Laminates - Typical Engineering Values

NX SERIES 2.70 - 3.20 0.0020 - 0.0024 Yes	-163dBc 50kV 10 <sup>8</sup> MΩ - cm 10 <sup>7</sup> MΩ 180 sec. 1586 MPa 131.0 MPa 2.33 kN / m 0.05% 2.25 g / cm <sup>3</sup> 0.251 W / m / K 12 ppm / °C 18 ppm / °C 150 ppm / °C V-0	Df         Product         Dk         Df           0.0016         NX9274         2.74±.04         0.0020           0.0015         NX9294         2.94±.04         0.0022           0.0017         NX9300         3.00±.04         0.0023           0.0018         NX9320         3.20±.04         0.0024           0.0019         0.0019         0.0024
NX SERIES 2.40 - 2.60 0.0016 - 0.0019 Yes	-163 dBc 50kV 10 <sup>9</sup> MΩ - cm 10 <sup>7</sup> MΩ 180 sec. 82.7 MPa 68.9 MPa 2.33 kN / m 2.31 kN / m 0.02% 2.23 g / cm <sup>3</sup> 0.272 W / m / K 25 ppm / °C 35 ppm / °C 260 ppm / °C 260 ppm / °C	Product Dk NX9240 2.40±.04 0.0 NX9245 2.45±.04 0.0 NX9250 2.50±.04 0.0 NX9255 2.55±.04 0.0 NX9260 2.60±.04 0.0
NY SERIES 2.08 - 2.33 0.0006 - 0.0011 Yes	-163 dBc 50kV 10 <sup>9</sup> MΩ - cm 10 <sup>7</sup> MΩ 180 sec. 82.7 MPa 68.9 MPa 2.33 kN / m 2.31 kN / m 0.02% 2.23 g / cm <sup>3</sup> 0.272 W / m / K 25 ppm / °C 35 ppm / °C 260 ppm / °C	Product         Dk         Df           NY9208         2.08±.02         0.0006           NY9217         2.17±.02         0.0008           NY9220         2.20±.02         0.0009           NY9233         2.33±.02         0.0011
Test Method nge) IPC-TM-650, 2.5.5.5 ge) IPC-TM-650, 2.5.5.5 vailability	IPC-TM-650, 2.5.6 IPC-TM-650, 2.5.17 IPC-TM-650, 2.5.17 ASTM D-495 IPC-TM-650, 2.4.4 IPC-TM-650, 2.4.4 IPC-TM-650, 2.4.8 oz, and 2 oz copper) IPC-TM-650, 2.6.2.1 ASTM D-792, A ASTM E-1225 IPC-TM-650, 2.4.41 IPC-TM-650, 2.4.41 IPC-TM-650, 2.4.41 IPC-TM-650, 2.4.41 IPC-TM-650, 2.4.24 IPC-TM-650, 2.4.24 IPC-TM-650, 2.4.24	
Typical Parameter  Dielectric Constant at 10 GHz (Dk) (range) IPC-TM-650, 2.5.5.5  Dissipation Factor at 10 GHz (Df) (range) IPC-TM-650, 2.5.5.5  Passive Intermodulation Formulation Availability	Passive Intermodulation Performance Dielectric Breakdown Volume Resistivity Surface Resistivity  Arc Resistance Flexural Strength Lengthwise Flexural Strength Crosswise Recard Strength Recar	

All test data provided are typical values and not intended to be specification values. For review of critical specification tolerances, please contact a company representative directly. \*DMA is the preferred method for measuring Tg - other methods may be less accurate.

Please specify the product and / or Dk, material thickness, copper thickness, copper type and panel size. Request Passive Intermodulation Formulation when necessary for antenna applications. Example: 9220, .010" thick, 1 oz two sides, ED copper, 12"x18". For Passive Intermodulation Formulation material, add the IM suffix, i.e.: 9220IM and specify N Copper.

## N9000 PTFE Laminates - Typical Engineering Values

NL SERIES 2.94 - 3.50 0.0017 Yes Pass	>50kV 6.1x10 <sup>7</sup> MΩ - cm 4.4x10 <sup>6</sup> MΩ - cm 215 sec. 58.6 MPa 64.1 / 48.9 MPa 1.8 kN / m (10.3 lb/in) <0.05% 2.25 g / cm <sup>3</sup> 0.381 W / m / K 25 ppm / °C 320 ppm / °C 320 ppm / °C 75 v-0 0.180 / 0.221	Product Dk Df NL9294 2.94±.05 0.0017 NL9300 3.00±.05 0.0017 NL9320 3.20±.05 0.0017 NL9350 3.50±.05 0.0017
Test Method IPC-TM-650, 2.5.5.5 IPC-TM-650, 2.5.5.5 dip IPC-TM-650, 2.6.16 iin) (modified)	PC-TM-650, 2.5.6 PC-TM-650, 2.5.17.1 PC-TM-650, 2.5.17.1 PC-TM-650, 2.5.17.1 PC-TM-650, 2.4.4.0 ASTM D3039 PC-TM-650, 2.4.8 IPC-TM-650, 2.4.8 IPC-TM-650, 2.4.24 IPC-TM-650, 2.4.24 IPC-TM-650, 2.3.10 ASTM D3039 ASTM D3039	
Typical Parameter  Typical Parameter  Dielectric Constant at 10 GHz (Dk)  Dissipation Factor at 10 GHz (Df)  PIM Formulation Availability  Pressure Cooker-60 min then solder dip IPC-TM-650, 2.5.5.6  @2288°C until failure (max 10 min) (modified)	Dielectric Breakdown Volume Resistivity Surface Resistivity Arc Resistance Flexural Strength Lengthwise Tensile Strength (warp/fill) Copper Peel Strength - 35 µm (1 oz) Moisture Absorption Specific Gravity Thermal Conductivity Coefficient of Thermal Expansion (CTE) X Y Flammability Poisson's Ratio (warp/fill)	
NH SERIES 2.94 - 4.50 0.0022 - 0.0030 Yes -163 dBc 45kV	108 MΩ - cm 107 MΩ 180 sec. 158.6 MPa 131.0 MPa 2.33 kN / m 0.08% 2.459 g / cm³ 0.230 W / m / K 9 ppm / °C 12 ppm / °C 71 ppm / °C 71 ppm / °C 71 ppm / °C V-0	Product         Dk         Df           NH9294         2.94±.07         0.0022           NH9300         3.00±.07         0.0023           NH9320         3.20±.07         0.0024           NH9338         3.38±.10         0.0025           NH9348         3.48±.10         0.0030           NH9350         3.50±.10         0.0030           NH9410         4.10±.10         0.0030           NH9450         4.50±.10         0.0030
Typical Parameter Dielectric Constant at 10 GHz (Dk) Dissipation Factor at 10 GHz (Df) PIM Formulation Availability Passive Intermodulation Performance Dielectric Breakdown	Volume Resistivity Surface Resistance Flexural Strength Lengthwise Flexural Strength Crosswise Copper Peel Strength - 18, 35, 70 µm (1/2 oz, 1 oz, and 2 oz copper) After Thermal Shock (30 sec. at 260°C) Moisture Absorption Specific Gravity Thermal Conductivity Coefficient of Thermal Expansion (CTE) X Y Flammability	

All test data provided are typical values and not intended to be specification values. For review of critical specification tolerances, please contact a company representative directly. \*DMA is the preferred method for measuring Tg - other methods may be less accurate.

		0.005	0.010	0.015	0.020	0.030	0.031	0.045	0.060	0.062	0.125
Series	Product	0.127	0.254	0.381	0.508	0.762	0.787	1.143	1.524	1.575	3.175
NY	9208				X	X		X	X		X
NY	9217	X	X	X	X	X	X	X	X	X	X
NY	9220	X	X	X	X	X	X	X	X	X	X
NY	9233	X	X	X	X	X	X	X	X	X	X
NX	9240	X	X	X	X	X	X	X	X	X	X
NX	9245	X	X	X	X	X	X	X	X	X	X
NX	9250	X	X	X	X	X	X	X	X	X	X
NX	9255	X	X	X	X	X	X	X	X	X	X
NX	9260	X	X	X	X	X	X	X	X	X	X
NX	9274				X	X	X	X	X	X	X
NX	9294				X	X	X	X	X	X	X
NX	9300				X	X	X	X	X	X	X
NX	9320				X	X	X	X	X	X	X
NH	9294	X	X		X	X	X		X	X	
NH	9300	X	X	X							
NH	9320	X	X	X	X						
NH	9338	X	X	X	X	X	X	X	X	X	X
NH	9348	X	X	X	X	X	X	X	X	X	X
NH	9350		X	X	X	X	X	X	X	X	X
NL	9294	X	X		X	X	X				
NL	9300	X	X		X	X	X				
NL	9320				X	X	X				
NL	9350				X	X	X				

Additional Materials for RF/Microwave Applications

Meteorwave 1000	Low Dk/Df Modified Epoxy Dk 3.40 / Df 0.0047 at 10 GHz	Mecurywave <sup>™</sup> 9350	Controlled Dk/Df Modified Epoxy Dk 3.50 / Df 0.004 at 10 GHz		
Meteorwave 2000	Low Dk/Df Modified Epoxy Dk 3.20 / Df 0.0034 at 10 GHz	N4350-13 RF	Controlled Dk/Df Modified Epoxy Dk 3.50 / Df 0.0065 at 10 GHz		
Meteorwave 3000	Low Dk/Df Modified Epoxy Dk 3.47 / Df 0.0039 at 10 GHz	N4380-13 RF	Controlled Dk/Df Modified Epoxy Dk 3.80 / Df 0.0070 at 10 GHz		
Meteorwave 4000	Low Dk/Df Modified Epoxy Dk 3.31 / Df 0.0024 at 10 GHz	Meteorwave 3350	Controlled Dk/Df Modified Epoxy Dk 3.50 / Df 0.0038 at 10 GHz		
Meteorwave 8000	Low Dk/Df Modified Epoxy Dk 3.28 / Df 0.0016 at 10 GHz	Meteorwave 8350	Controlled Dk/Df Modified Epoxy Dk 3.50 / Df 0.0018 at 10 GHz		
<b>Bond Ply Mater</b>	ials	N9000-13 RF	PTFE and Epoxy Composite Dk 3.00 / Df 0.0040 at 10 GHz		
$M$ -Pl $y^{\text{\tiny TM}}$	Ultra Low Loss Bonding Ply Dk 3.28 / Df 0.0020 at 10 GHz		Dk 3.20 / Df 0.0045 at 10 GHz Dk 3.38 / Df 0.0046 at 10 GHz Dk 3.50 / Df 0.0055 at 10 GHz		
Meteorwave 1000NF	Low Dk/Df No Flow Prepreg Dk 3.40 / Df 0.0047 at 10 GHz				